



Features

- Hot-pluggable XFP footprint
- Supports 9.95Gb/s to 11.3Gb/s bit rates
- Supports Lineside and XFI loopback
- RoHS-6 Compliant (lead-free)
- Power dissipation <2W
- Maximum link length of 60km
- Uncooled CWDM DFB Laser and APD Receiver
- Full Duplex LC connector
- No Reference Clock required
- Built-in digital diagnostic functions
- Standard bail release mechanism
- Case temperature range:-5°C to 70°C

Aapplication

- 10GBASE-ER/EW ,10G Ethernet
- Fiber Channel
- SONET OC-192&SDH STM-64

Ordering Information

PART NUMBER	TX/RX	INPUT/OUTPUT	SIGNAL DETECT	TEMPERATURE	Distance
CL-XFP-C60-XX	-	AC/AC	TTL	-5°C to 70 °C	60km
CL-XFP-C60-XXI		AC/AC	TTL	-25°C to 85 °C	60km

Description

Carelink's CL-XFP-C60-XX Small Form Factor 10Gb/s (XFP) transceivers are compliant with the current XFP Multi-Source Agreement (MSA) Specification. They comply with 10-Gigabit Ethernet 10GBASE-ER/EW per IEEE 802.3ae.Digital diagnostics functions are available via a 2-wire serial interface, as specified in the XFP MSA. The transceiver is RoHS compliant and leads free per Directive 2002/95/EC 3

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PRODUCT SELECTION

Wavelength	XX	Wavelength	xx
1270 nm	27	1370 nm	37
1290 nm	29	1390 nm	39
1310 nm	31	1410 nm	41
1330 nm	33	1430 nm	43
1350 nm	35	1450 nm	45

I. Absolute Maximum Ratings

Parameter	Symbol	Min	Тур	Max	Unit	NOTE
Maximum Supply Voltage	Vcc3	-0.5		4.0	V	
Storage Temperature	Ts	-40	>	85	°C	
Case Operating Temperature	Tcase	0		70	°C	

II. Electrical Characteristics

Parameter	Symbol	Min	Тур	Max	Unit	NOTE
Supply Voltage #2	Vcc3	3.13	-JP	3.45	V	NOIL
Supply Current – Vcc3 supply	Icc3			550	mA	
Module total power	P			2	w	1
Transmitter						
Input differential impedance	Rin		100		Ω	2
Differential data input swing	Vin,pp	120		820	mV	
Transmit Disable Voltage	VD	2.0		Vec	V	3
Transmit Enable Voltage	Ven	GND		GND+ 0.8	V	
Transmit Disable Assert Time				10	us	
Receiver						
Differential data output swing	Vout,pp	340	650	850	mV	4
Data output rise time	tr			38	ps	5
Data output fall time	tf			38	ps	5
LOS Fault	VLOS fault	Vcc - 0.5		Vechost	V	6
LOS Normal	VLOS norm	GND		GND+0.5	V	6
Power Supply Rejection	PSR		See	Note 6 below		7



Notes:

- 1. Maximum total power value is specified across the full temperature and voltage range.
- 2. After internal AC coupling.
- 3. Or open circuit.
- 4. Into 100 ohms differential termination.
- 5. These are unfiltered 20-80% values
- 6. Loss Of Signal is open collector to be pulled up with a 4.7k 10kohm resistor to 3.15 3.6V. Logic 0 indicates normal operation; logic 1 indicates no signal detected.
- 7. Per Section 2.7.1. in the XFP MSA Specification1.

|||. Optical Characteristics

Parameter	Symbol	Min	Тур	Max	Unit	NOTE		
Transmitter								
Average Optical Power	Pf	0		5	dBm			
Optical Wavelength	λ	λ-6.5	λ+1	λ+6.5	nm	1		
Side mode Suppression ratio	SMSR	30			dB			
Optical Extinction Ratio	ER	3.5			dB			
Transmitter and Dispersion Penalty	TDP			3.2	dB			
Average Launch power of OFF transmitter	Рогг			-30	dBm			
Relative Intensity Noise	RIN			-130	dB/Hz			
Receiver								
Receiver Sensitivity	Psen			-20	dBm	2		
Input Saturation Power (Overload)	Psat	-6			dBm			
Wavelength Range	λ _c	1270		1610	nm			
Receiver Reflectance	Rrx			-27	dB			
LOS De-Assert	LOSD			-23	dBm			
LOS Assert	LOSA	-35			dBm			
LOS Hysteresis		0.5			dВ			

Notes:

- 1. " λ " is:1270,1290,1310,1330,1350,1370,1390,1410,1430,1450, please the "product selection" .
- 2. Measured with BER<10-12@10.3Gbps,231-1 PRBS.



IV. Pin Assignment

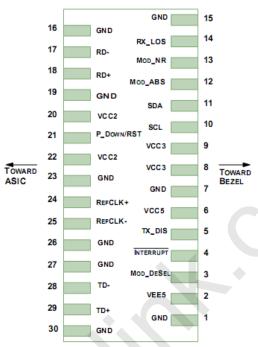


Diagram of Host Board Connector Block Pin Numbers and Name

Pin	Logic	Symbol	Name/Description	NOTE
1		GND	Module Ground	
2		VEE5	Optional –5.2 Power Supply – Not required	
3	LVTTL-I	Mod-Desel	Module De-select; When held low allows the module to respond to 2-wire serial interface commands	
4	LVTTL-O	Interrupt	Interrupt (bar); Indicates presence of an important condition which can be read over the serial 2-wire interface	2
5	LVTTL-I	TX_DIS	Transmitter Disable; Transmitter laser source turned off	
6		VCC5	+5 Power Supply	
7		GND	Module Ground	1
8		VCC3	+3.3V Power Supply	
9		VCC3	+3.3V Power Supply	
10	LVTTL-I	SCL	Serial 2-wire interface clock	2
11	LVTTLI/O	SDA	Serial 2-wire interface data line	2



LVTTL-O	Mod_Abs	Module Absent; Indicates module is not present. Grounded in the module.	2
LVTTL-O	Mod_NR	and	
LVTTL-O	RX_LOS	Receiver Loss of Signal indicator	2
	GND	Module Ground	1
	GND	Module Ground	1
CML-O	RD-	Receiver inverted data output	
CML-O	RD+	Receiver non-inverted data output	
	GND	Module Ground	1
	VCC2	+1.8V Power Supply – Not required	
LVTTL-I	P_Down/RST	Power Down; When high, places the module in the low power stand-by mode and on the falling edge of P_Down initiates a module reset	
		Reset; The falling edge initiates a complete reset of the module including the 2-wire serial interface, equivalent to a power cycle.	
	VCC2	+1.8V Power Supply – Not required	
	GND	Module Ground	1
PECL-I	RefCLK+	Reference Clock non-inverted input, AC coupled on the host board – Not required	3
PECL-I	RefCLK-	Reference Clock inverted input, AC coupled on the host board – Not required	3
	GND	Module Ground	1
	GND	Module Ground	1
CML-I	TD-	Transmitter inverted data input	
CML-I	TD+	Transmitter non-inverted data input	
	GND	Module Ground	1
	LVTTL-O LVTTL-O CML-O CML-O LVTTL-I PECL-I PECL-I CML-I	LVTTL-O Mod_NR LVTTL-O RX_LOS GND GND CML-O RD- CML-O RD+ GND VCC2 LVTTL-I P_Down/RST VCC2 GND PECL-I RefCLK+ PECL-I RefCLK- GND GND CML-I TD- CML-I TD+	LVTTL-O Mod_NR Module Not Ready; CARELINK defines it as a logical OR between RX_LOS and and and interpretation of the properties of Signal indicator RX_LOS Receiver Loss of Signal indicator GND Module Ground Module Ground CML-O RD- Receiver inverted data output CML-O RD+ Receiver non-inverted data output GND Module Ground VCC2 +1.8V Power Supply – Not required Power Down; When high, places the module in the low power stand-by mode and on the falling edge of P_Down initiates a module reset Reset; The falling edge initiates a complete reset of the module including the 2-wire serial interface, equivalent to a power cycle. VCC2 +1.8V Power Supply – Not required GND Module Ground PECL-I RefCLK+ Reference Clock non-inverted input, AC coupled on the host board – Not required GND Module Ground GND Module Ground GND Module Ground CML-I TD- Transmitter inverted data input CML-I TD- Transmitter inverted data input

Notes

- 1. Module circuit ground is isolated from module chassis ground within the module.
- 2. Open collector; should be pulled up with 4.7k 10kohms on host board to a voltage between 3.15V and 3.6V.
- 3. A Reference Clock input is not required by the CL-XFP-C60-XX. If present, it will be ignored.



V. General Specifications

Parameter	Symbol	Min	Тур	Max	Units	NOTE
Bit Rate	BR	9.95		11.3	Gb/s	1
Bit Error Ratio	BER			10 ⁻¹²		2
Max. Supported Link Length	Lmax		60		km	1

Notes:

- 1. 10GBASE-ER/EW.
- 2. Tested with 10.3Gbps, 231–1 PRBS

VI. Digital Diagnostic Functions

As defined by the XFP MSA1, Carelink XFP transceivers provide digital diagnostic functions via a 2-wire serial interface, which allows real-time access to the following operating parameters:

- Transceiver temperature
- Laser bias current
- Transmitted optical power
- Received optical power
- Transceiver supply voltage

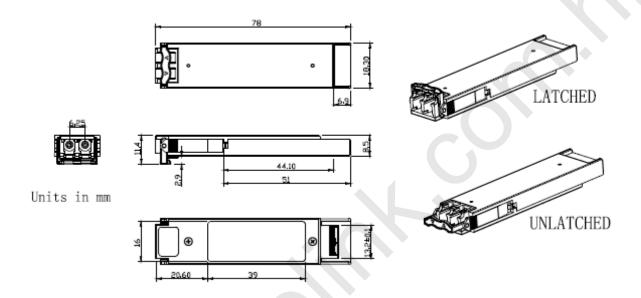
It also provides a sophisticated system of alarm and warning flags, which may be used to alert end-users when particular operating parameters are outside of a factory-set normal range.

The operating and diagnostics information is monitored and reported by a Digital Diagnostics Transceiver Controller (DDTC) inside the transceiver, which is accessed through the 2-wire serial interface. When the serial protocol is activated, the serial clock signal (SCL pin) is generated by the host. The positive edge clocks data into the XFP transceiver into those segments of its memory map that are not write-protected. The negative edge clocks data from the XFP transceiver. The serial data signal (SDA pin) is bi-directional for serial data transfer. The host uses SDA in conjunction with SCL to mark the start and end of serial protocol activation. The memories are organized as a series of 8-bit data words that can be addressed individually or sequentially. The 2-wire serial interface provides sequential or random access to the 8 bit parameters, addressed from 000h to the maximum address of the memory.

For more detailed information including memory map definitions, please see the XFP MSA Specification.

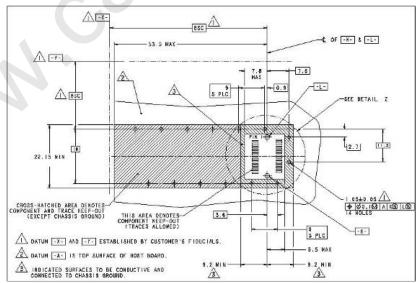
VII. Mechanical Specifications

Carelink's XFP transceivers are compliant with the dimensions defined by the XFP Multi-Sourcing Agreement (MSA).



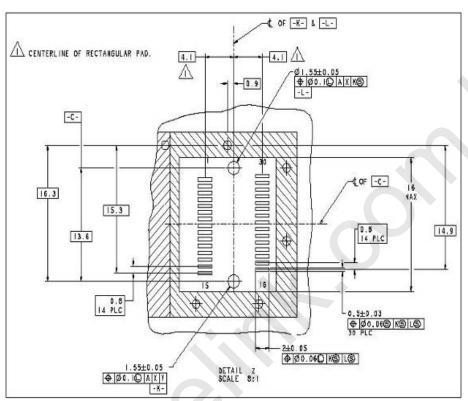
XFP Transceiver (dimensions are in mm)

VIII. PCB Layout and Bezel Recommendations

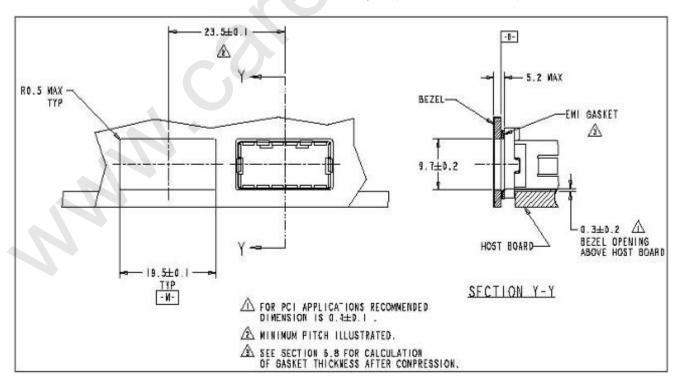


XFP Host Board Mechanical Layout (dimensions are in mm)





XFP Detail Host Board Mechanical Layout (dimensions are in mm)





IX. Regulatory Compliance

Feature	Reference	Performance	
Electrostatic discharge (ESD)	IEC/EN 61000-4-2	Compatible with standards	
Electromagnetic Interference (EMI)	FCC Part 15 Class B EN 55022 Class B (CISPR 22A)	Compatible with standards	
Laser Eye Safety	FDA 21CFR 1040.10, 1040.11 IEC/EN 60825-1, 2	Class 1 laser product	
Component Recognition	IEC/EN 60950 , UL	Compatible with standards	
ROHS	2002/95/EC	Compatible with standards	
EMC	EN61000-3	Compatible with standards	